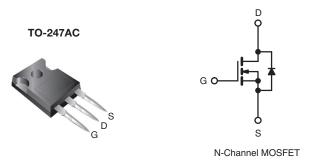


### Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	900			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	3.7		
Q <sub>g</sub> (Max.) (nC)	78			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	42			
Configuration	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPF30PbF
Leau (FD)-iree	SiHFPF30-E3
SnPb	IRFPF30
SIFD	SiHFPF30

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	900	V	
Gate-Source Voltage	$V_{GS}$	± 20			
Continuous Drain Current	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	_	3.6	А	
	$T_C = 100 ^{\circ}C$	I <sub>D</sub>	2.3		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	14			
Linear Derating Factor			1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	170	mJ		
Repetitive Avalanche Current <sup>a</sup>	I <sub>AR</sub>	3.6	А		
Repetitive Avalanche Energy <sup>a</sup>	E <sub>AR</sub>	13	mJ		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	125	W	
Peak Diode Recovery dV/dtc		dV/dt	1.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	nperature) for 10 s 300 <sup>d</sup>		300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
	0-32 OF IVIS SCIEW		1.1	N·m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 24 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.6 A (see fig. 12).
- c.  $I_{SD} \le 3.6$  A,  $dI/dt \le 70$  A/ $\mu$ s,  $V_{DD} \le 600$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	40	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.0	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		900	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	Reference to 25 °C, I <sub>D</sub> = 1 mA		1.1	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
7 0 1 1/1 1 2 1 2 1	I <sub>DSS</sub>	V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V		-	-	100	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 720 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.2 A <sup>b</sup>	-	-	3.7	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 100 V, I <sub>D</sub> = 2.2 A <sup>b</sup>		2.3	-	-	S
Dynamic		<u>.</u>					
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	1200	-	pF
Output Capacitance	C <sub>oss</sub>			-	320	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0	MHz, see fig. 5	-	200	-	1
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 3.6 \text{ A}, V_{DS} = 360 \text{ V}$ see fig. 6 and 13 <sup>b</sup>	-	-	78	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	10	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	42	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 450 V, $I_{D}$ = 3.6 A, $R_{g}$ = 12 Ω, $R_{D}$ = 120 Ω, see fig. 10 <sup>b</sup>		-	14	-	- ns
Rise Time	t <sub>r</sub>			-	25	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	90	-	
Fall Time	t <sub>f</sub>			-	30	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	الم
Internal Source Inductance	L <sub>S</sub>			-	13	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			_	-	14	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub>	$_{S} = 3.6 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	1	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 3.6 A, dI/dt = 100 A/μs <sup>b</sup>		-	430	650	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			_	1.4	2.1	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

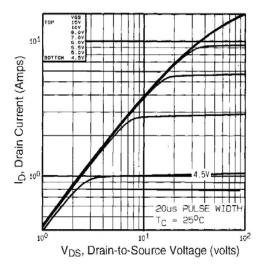


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

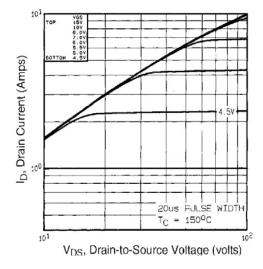


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

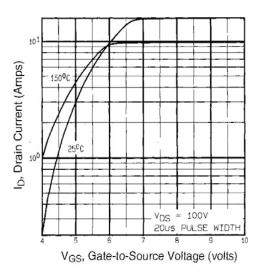


Fig. 3 - Typical Transfer Characteristics

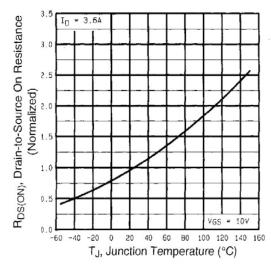


Fig. 4 - Normalized On-Resistance vs. Temperature



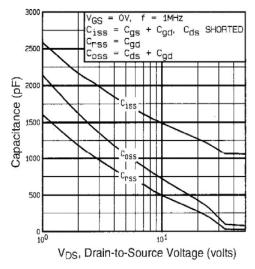


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

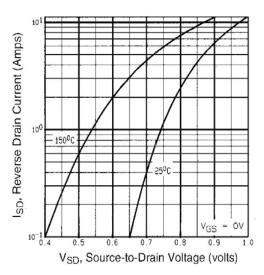


Fig. 7 - Typical Source-Drain Diode Forward Voltage

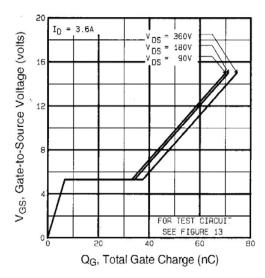


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

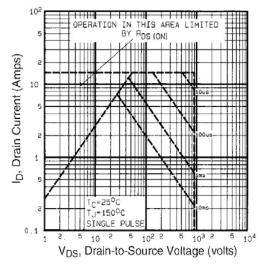


Fig. 8 - Maximum Safe Operating Area





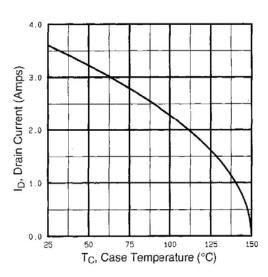


Fig. 9 - Maximum Drain Current vs. Case Temperature

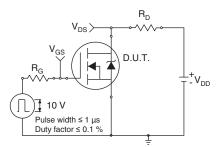


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

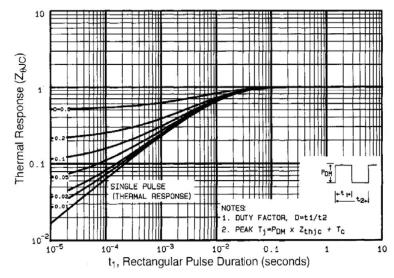


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



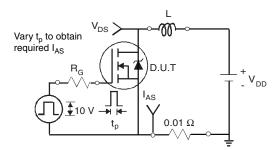


Fig. 12a - Unclamped Inductive Test Circuit

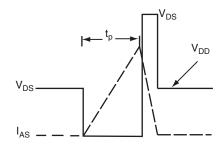


Fig. 12b - Unclamped Inductive Waveforms

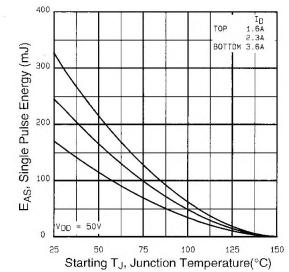


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

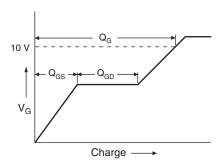


Fig. 13a - Basic Gate Charge Waveform

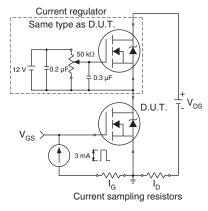
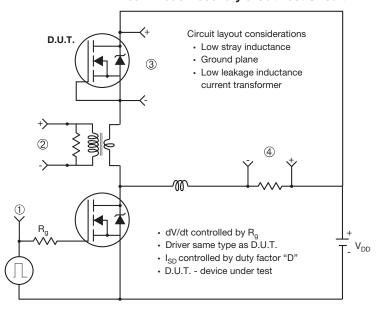


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



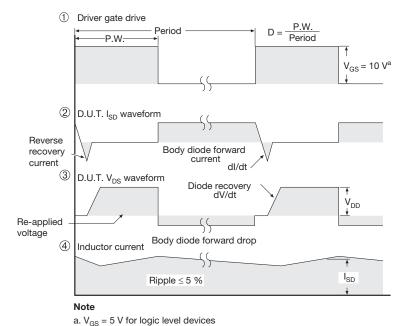


Fig. 14 - For N-Channel

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